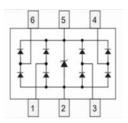


Discription

The HAZC015-04C is a 5-channel ultra low capacitance rail clamp ESD protection diodes array. Each channel consists of a pair of ESD diodes that steer positive or negative ESD current to either the positive or negative rail. A zener diode is integrated in to the array between the positive and negative supply rails. In the typical applications, the negative rail pin (assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped to the zener voltage.



SOT-363



Circuit Diagram

Features

- ★ 5 channels of ESD protection
- ★ Provides ESD protection to IEC61000-4-2 level 4
 - ±27kV air discharge
 - ±15kV contact discharge
- ★ Low clampingvoltage
- ★ Low operating voltage
- ★ Improved zener structure
- ★ Optimized package for easyhigh speed data lines PCB layout
- ★ RoHS compliant

Orderingin formation

| Product ID | Pack | Qty(PCS) |
|-------------|---------|----------|
| HAZC015-04C | SOT-363 | 3000 |

Absolute Ratings(Tamb = 25°C)

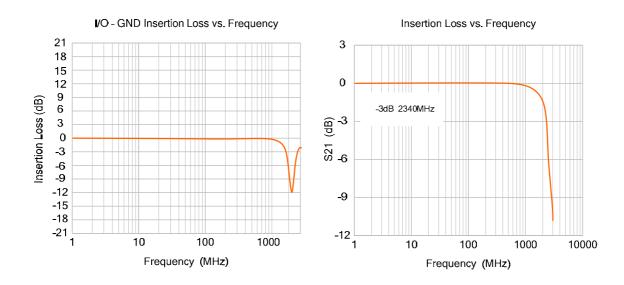
| Characteristics | Symbol | Ratings | Unit |
|--------------------------------|-------------------|------------|------|
| Peak Pulse Power(8/20µs) | P_PP | 55 | W |
| Peak Pulse Current(8/20µs) | I _{PP} | 4 | А |
| ESD per IEC 61000-4-2(Air) | V_{ESD1} | ±20kV | kV |
| ESD per IEC 61000-4-2(Contact) | V _{ESD2} | ±15kV | kV |
| Operating Temperature Range | Topr | -55 ~ +125 | °C |
| Storage Temperature Range | Tstg | -55 ~ +150 | °C |

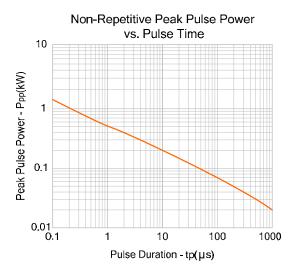


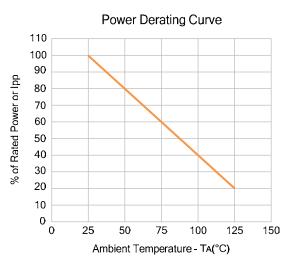
Electrical Characteristics (Tamb=25°C)

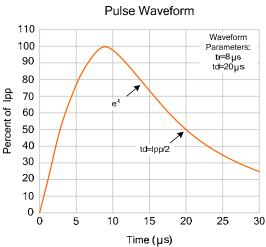
| Characteristics | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|------------------------------|-----------------|---|------|------|------|------|
| Reverse Working | | Any I/O pin to GND | | | 5 | V |
| Voltage | V_{RWM} | | | | 5 | V |
| Reverse Breakdown | | I t=1mA; | 6 | | | V |
| Voltage | V_{BR} | Any I/O pin to GND | | | | |
| Reverse Leakage | I _R | V _{RWM} =5V, T=25°C; | | | 1 | μА |
| Current | | Any I/O pin to GND | | | 1 | |
| Decitive Clarenine | V _{C1} | I _{PP} =1A, t _P =8/20 µs; | | | | V |
| Positive Clamping Voltage | | Positive pulse; | | 13 | 13.0 | |
| | | Any I/O pin to GND | | | | |
| Negative Clamping | V _{C2} | I _{PP} =1A, t _P =8/20μs; | | 1.8 | | V |
| Negative Clamping Voltage | | Negative pulse; | | | | |
| | | Any I/O pin to GND | | | | |
| Junction Capacitance | _ | V _R =0V, f=1MHz; | | 0.2 | 0.4 | 25 |
| Between Channel | C_{J1} | Between I/O pins | 0.3 | | 0.4 | pF |
| Junction Capacitance | C _{J2} | V _R =0V, f=1MHz; | | 0.6 | 0.8 | pF |
| Between I/O And GND | | Any I/O pin to GND | | | | |

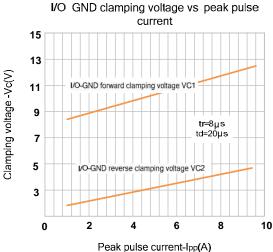
Typical Characteristics

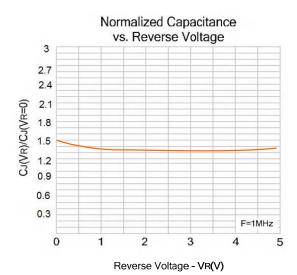




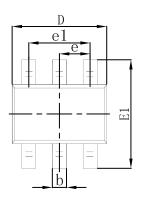


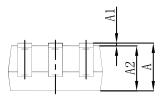


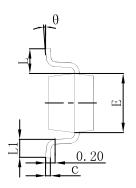




SOT-363 Package Outline Dimensions

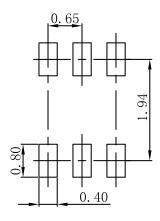






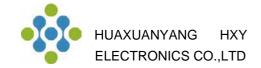
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|-------|----------------------|-------|--|
| | Min | Max | Min | Max | |
| Α | 0.900 | 1.100 | 0.035 | 0.043 | |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 | |
| A2 | 0.900 | 1.000 | 0.035 | 0.039 | |
| b | 0.150 | 0.350 | 0.006 | 0.014 | |
| С | 0.100 | 0.150 | 0.004 | 0.006 | |
| D | 2.000 | 2.200 | 0.079 | 0.087 | |
| E | 1.150 | 1.350 | 0.045 | 0.053 | |
| E1 | 2.150 | 2.400 | 0.085 | 0.094 | |
| е | 0.650 TYP | | 0.026 TYP | | |
| e1 | 1.200 | 1.400 | 0.047 | 0.055 | |
| Ĺ | 0.525 REF | | 0.021 REF | | |
| L1 | 0.260 | 0.460 | 0.010 | 0.018 | |
| θ | 0° | 8° | 0° | 8° | |

SOT-363 Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.



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